

January 2007

## FSUSB31

# Low-Power 1-Port Hi-Speed USB 2.0 (480Mbps) Switch

### **Features**

- Low On capacitance, 3.7pF (typical)
- Low On resistance,  $6.5\Omega$  (typical)
- Low power consumption (1µA maximum)
  - 10μA maximum I<sub>CCT</sub> over and expanded control voltage range (V<sub>IN</sub> = 2.6V, V<sub>CC</sub> = 4.3V)
- Wide -3dB bandwidth. > 720MHz
- 8K I/O to GND ESD protection
- Power OFF protection when V<sub>CC</sub> = 0V, D+/D- pins can tolerate up to 4.3V
- Packaged in:
  - Pb-Free 8-lead MicroPak™ (1.6 x 1.6mm)
  - Pb-Free 8-lead US8

### **Applications**

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

### **Related Application Notes**

■ AN-6022 Using the FSUSB30/31 to Comply with USB 2.0 Fault Condition Requirements

### **Description**

The FSUSB31 is a low-power, single-port, high-speed USB 2.0 switch. This part is configured as a single pole, single-throw switch and is optimized for switching or isolating a high-speed (480Mbps) source or a high-speed and full-speed (12Mbps) source. The FSUSB31 is compatible with the requirements of USB2.0 and features an extremely low on capacitance (C<sub>ON</sub>) of 3.7pF. The wide bandwidth of this device (>720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk minimizes interference.

The FSUSB31 contains special circuitry on the D+/D-pins that allows the device to withstand an over-voltage condition. This device is also designed to minimize current consumption even when the control voltage applied to the  $\overline{\text{OE}}$  pin is lower than the supply voltage (V<sub>CC</sub>). This feature is especially valuable for ultra-portable applications such as cell phones, allowing for direct interface with the general purpose I/Os of the baseband processor. Other applications include port isolation and switching in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

### **Ordering Information**

Part Number	t Number Package Pb-Free Package Description			
FSUSB31K8X	MAB08A	Yes	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	
FSUSB31L8X	SUSB31L8X MAC08A Yes		8-Lead MicroPak, 1.6mm Wide	

Pb-Free package per JEDEC J-STD-020B.

## **Application Diagram**

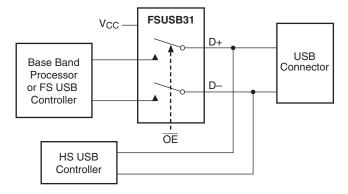


Figure 1. Typical Application Diagram

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

## **Connection Diagrams**

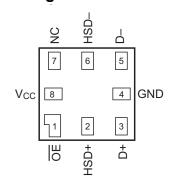


Figure 2. Pin Assignments for MicroPak

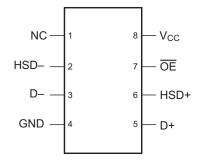


Figure 3. Pin Assignments for US8

## **Analog Symbol**

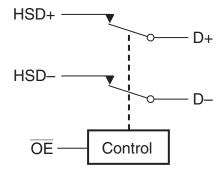


Figure 4. Analog Symbol

## **Pin Descriptions**

Pin Name	Description
ŌĒ	Bus Switch Enable
D+, D-, HSD+, HSD-	Data Ports
NC	No Connect

### **Truth Table**

ŌĒ	Function
HIGH	Disconnect
LOW	D+, D- = HSD

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Minimum	Maximum	Unit
V <sub>CC</sub>	Supply Voltage		-0.5V	4.6	V
V <sub>S</sub>	DC Input Voltage <sup>(1)</sup>		-0.5V	4.6	V
W	DC Switch Voltage <sup>(1)</sup>	HSD	-0.5V	V <sub>CC</sub> +0.3	V
V <sub>IN</sub>	DC Switch voltage	D+, D-	-0.5	+4.6	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
I <sub>OUT</sub>	DC Output Current	DC Output Current		50	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
ESD	Human Body Model	All Pins		7.5	kV
ESD	Truman Body Model	I/O to GND		8	kV

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Minimum	Maximum	Unit
V <sub>CC</sub>	Supply Voltage	3.0	4.3	V
V <sub>IN</sub>	Control Input Voltage <sup>(2)</sup>	0V	V <sub>CC</sub>	V
	Switch Input Voltage	0V	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C

#### Notes:

- 1. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed. DC switch voltage may never exceed 4.6V.
- 2. Control input must be held HIGH or LOW and it must not float.

### **DC Electrical Characteristics**

All typical values are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -	Unit			
Symbol	Parameter	Conditions	ACC (A)	Min.	Тур.	Max.	Oilit	
V <sub>IK</sub>	Clamp Diode Voltage	I <sub>IN</sub> = -18mA	3.0			-1.2	V	
V	Input Voltage HIGH		3.0 to 3.6	1.3			V	
V <sub>IH</sub>	input voltage riiGri		4.3	1.7				
V	Input Voltage LOW		3.0 to 3.6			0.5	V	
V <sub>IL</sub>	Input voltage LOW		4.3			0.7		
I <sub>IN</sub>	Control Input Leakage	V <sub>IN</sub> = 0V to V <sub>CC</sub>	4.3	-1.0		1.0	μΑ	
I <sub>OZ</sub>	OFF State Leakage	$0 \le HSD \le V_{CC}$	4.3	-2.0		2.0	μΑ	
I <sub>OFF</sub>	Power OFF Leakage Current (D+, D–)	V <sub>IN</sub> = 0.0V to 4.3V, V <sub>CC</sub> = 0V	0	-2.0		2.0	μА	
R <sub>ON</sub>	Switch On Resistance <sup>(3)</sup>	$V_{IN} = 0.4V$ , $I_{ON} = -8mA$	3.0		6.5	10.0	Ω	
ΔR <sub>ON</sub>	Delta R <sub>ON</sub> <sup>(4)</sup>	$V_{IN} = 0.4V$ , $I_{ON} = -8mA$	3.0		0.35		Ω	
R <sub>ON</sub> Flatness	R <sub>ON</sub> Flatness <sup>(3)</sup>	$V_{IN} = 0.0V - 1.0V,$ $I_{ON} = -8mA$	3.0		2.0		Ω	
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = 0.0V \text{ or } V_{CC},$ $I_{OUT} = 0$	4.3			1.0	μА	
Ісст	Increase in I <sub>CC</sub> Current per Control Voltage and V <sub>CC</sub> Levels	V <sub>IN</sub> = 2.6V, V <sub>CC</sub> = 4.3V	4.3			10.0	μΑ	

### Notes:

- 3. Measured by the voltage drop between Dn, HSD, and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two ports.
- 4. Guaranteed by characterization.

## **AC Electrical Characteristics**

All typical values are for  $V_{CC}$  = 3.3V are at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -	40°C to	+85°C	Unit	Figure
Symbol	i arameter	Conditions	100(1)	Min.	Тур.	Max.	Offic	Number
t <sub>ON</sub>	Turn-On Time, OE to Output	$V_{IN}$ = 0.8V, $R_L$ = 50 $\Omega$ , $C_L$ = 5pF	3.0 to 3.6		15.0	30.0	ns	Figure 12
t <sub>OFF</sub>	Turn-Off Time, OE to Output	$V_{IN}$ = 0.8V, $R_L$ = 50 $\Omega$ , $C_L$ = 5pF	3.0 to 3.6		12.0	25.0	ns	Figure 12
t <sub>PD</sub>	Propagation Delay <sup>(4)</sup>	$R_L = 50\Omega$ , $C_L = 5pF$	3.3		0.25		ns	Figure 10 Figure 11
t <sub>BBM</sub>	Break-Before-Make	$R_L = 50\Omega, C_L = 5pF,$ $V_{IN} = 0.8V$	3.0 to 3.6	2.0		6.5	ns	Figure 13
O <sub>IRR</sub>	Off Isolation (Non-Adjacent)	$R_T = 50\Omega$ , $f = 240MHz$	3.0 to 3.6		-35.0		dB	Figure 16
Xtalk	Non-Adjacent Channel Crosstalk	$R_T = 50\Omega$ , $f = 240MHz$	3.0 to 3.6		-55.0		dB	Figure 17
BW	-3dB Bandwidth	$R_T = 50\Omega$ , $C_L = 0pF$	3.0 to 3.6		720		MHz	Figure 15
DVV	-Jub Danuwium	$R_T = 50\Omega$ , $C_L = 5pF$	3.0 10 3.0		550		IVII IZ	i iguie 15

## **USB Hi-Speed Related AC Electrical Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Unit	Figure Number	
				Min.	Тур.	Max.		Number
t <sub>SK(O)</sub>	Channel-to-Channel Skew <sup>(5)</sup>	C <sub>L</sub> = 5pF	3.0 to 3.6		50.0		ps	Figure 10 Figure 14
t <sub>SK(P)</sub>	Skew of Opposite Transitions of the Same Output <sup>(5)</sup>	C <sub>L</sub> = 5pF	3.0 to 3.6		20.0		ps	Figure 10 Figure 14
tJ	Total Jitter <sup>(5)</sup>	$R_L = 50\Omega$ , $C_L = 5pF$ , $t_R = t_F = 500ps$ at 480 Mbps $(PRBS = 2^{15} - 1)$	3.0 to 3.6		200		ps	

#### Note:

5. Guaranteed by design.

## Capacitance

Symbol Parameter		Conditions	T <sub>A</sub> = -	40°C to	Unit	Figure	
Syllibol	Farameter	Conditions	Min.	Тур.	Max.		Number
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> = 0V		1.0		pF	Figure 19
C <sub>ON</sub>	D1 <sub>n</sub> , D2 <sub>n</sub> , Dn On Capacitance	$V_{CC} = 3.3, \overline{OE} = 0V$		3.7		pF	Figure 18
C <sub>OFF</sub>	D1 <sub>n</sub> , D2 <sub>n</sub> Off Capacitance	$V_{CC}$ and $\overline{OE}$ = 3.3		1.7		pF	Figure 19

## **Typical Characteristics**

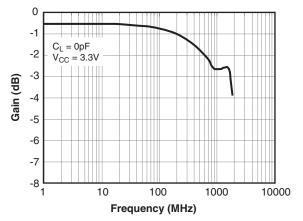


Figure 5. Gain vs. Frequency

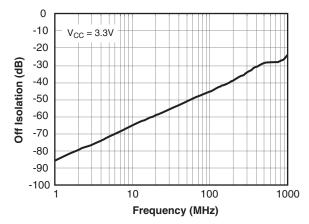


Figure 6. Off Isolation

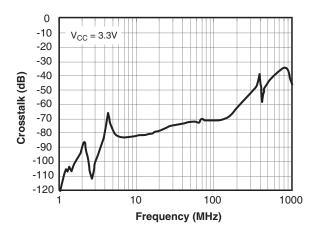


Figure 7. Crosstalk

## **Test Diagrams**

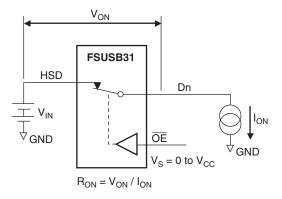
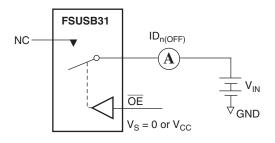
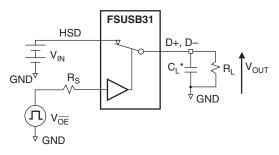


Figure 8. On Resistance



Each switch port is tested separately.

Figure 9. Off Leakage



 $\rm R_L,\,\rm R_S,$  and  $\rm C_L$  are functions of the application environment (see AC Electrical tables for specific values).

\*C<sub>L</sub> includes test fixture and stray capacitance.

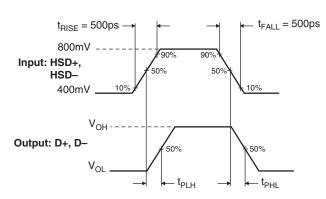
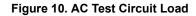


Figure 11. Switch Propagation Delay Waveforms  $(t_{PD})$ 



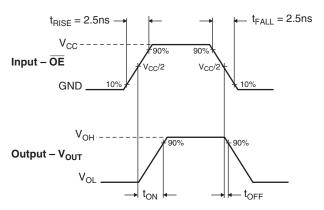
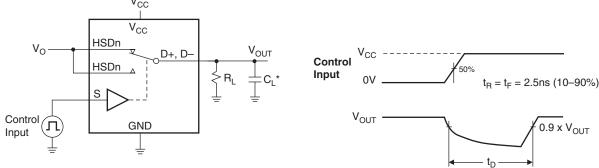


Figure 12. Turn On / Turn Off Waveform ( $t_{ON}$  /  $t_{OFF}$ )

### **Test Diagrams** (Continued)



\*C<sub>L</sub> includes test fixture and stray capacitance.

Figure 13. Break-Before-Make (t<sub>BBM</sub>)

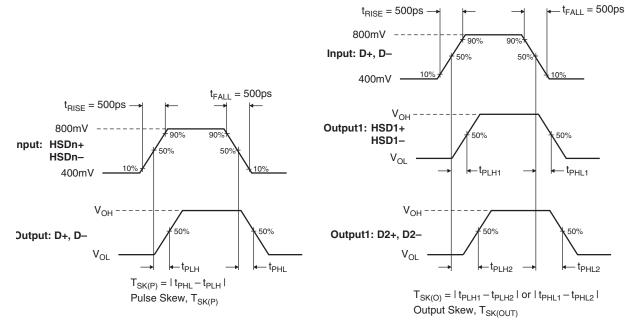


Figure 14. Switch Skew Tests

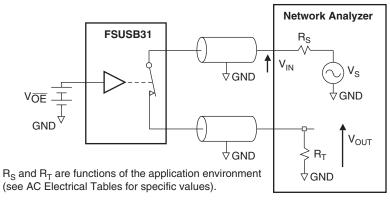


Figure 15. Bandwidth

## Test Diagrams (Continued)

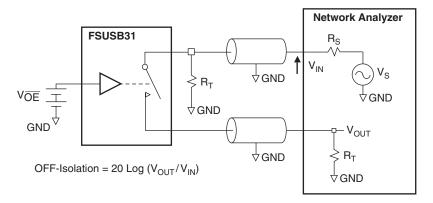


Figure 16. Channel Off Isolation

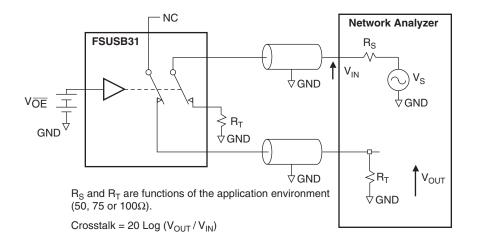


Figure 17. Non-Adjacent Channel-to-Channel Crosstalk

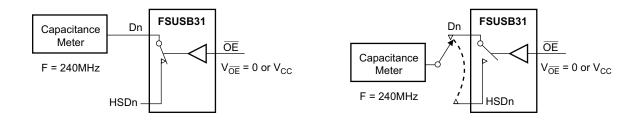


Figure 18. Channel On Capacitance

Figure 19. Channel Off Capacitance

### Application Guidance: Meeting USB 2.0 Vbus Short Requirements

In section 7.1.1 of the USB 2.0 specification, it notes that USB devices must be able to withstand a Vbus short to D+ or D- when the USB devices is either powered off or powered on. The FSUSB31 can be successfully configured to meet both these requirements.

#### **Power-Off Protection**

For a Vbus short circuit, the switch is expected to withstand such a condition for at least 24 hours. The FSUSB31 has specially designed circuitry which prevents unintended signal bleed through as well as guaranteed system reliability during a power-down, overvoltage condition. The protection has been added to the common pins (D+, D-).

#### **Power-On Protection**

The USB 2.0 specification also notes that the USB device should be capable of withstanding a Vbus short during transmission of data. Fairchild recommends adding a  $100\Omega$  series resister between the switch VCC pin and supply rail to protect against this case. This modification works by limiting current flow back into the VCC rail during the over-voltage event so current remains within the safe operating range. In this application, the switch passes the full 5.25V input signal through to the selected output, while maintaining specified off isolation on the un-selected pins.

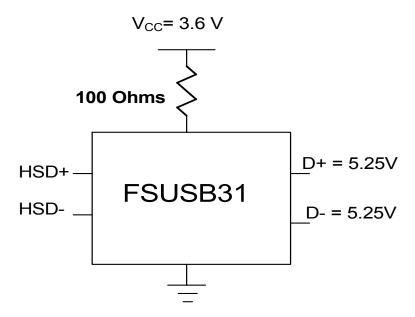


Figure 20. A 100 $\Omega$  resistor in series with the V<sub>CC</sub> supply allows the FSUSB31 to withstand a Vbus short when powered up

For more information, see Applications Note AN-6022 Using the FSUSB30/FSUSB31 to Comply with USB 2.0 Fault Condition Requirements at <a href="https://www.fairchildsemi.com">www.fairchildsemi.com</a>

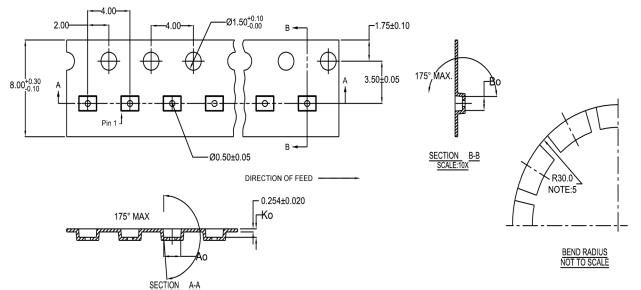
## **Tape and Reel Specification**

### **Tape Format for MircoPak**

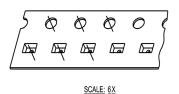
Package Designator	·		Cavity Status	Cover Tape Status
	Leader (Start End)	125 (typ)	Empty	Sealed
L8X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

### **Tape Dimension**

Dimensions are in millimeters unless otherwise specified.



10	300056	2.30±0.05	1.78±0.05	0.68 ± 0.05
8	300038	1.78±0.05	1.78±0.05	$0.68 \pm 0.05$
6	300033	1.60 ± 0.05	1.15±0.05	0.70 ± 0.05

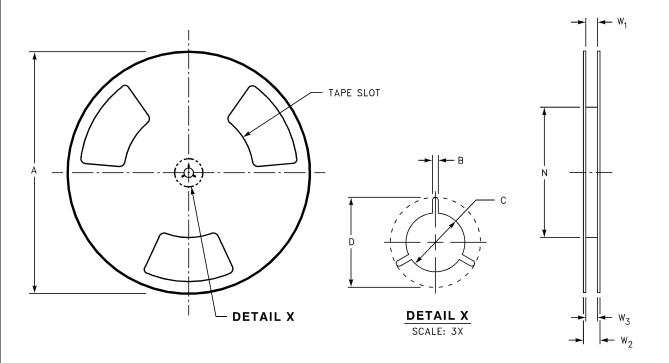


NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ACCUMULATED 50 SPROCKETS, SPROCKET HOLE PITCH IS 200.00  $\pm 0.30 \mathrm{MM}$
- 2. NO INDICATED CORNER RADIUS IS 0.127MM
- 3. CAMBER NOT TO EXCEED 1MM IN 100MM
- 4. SMALLEST ALLOWABLE BENDING RADIUS
- 5. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE

### **Reel Dimension for MircoPak**

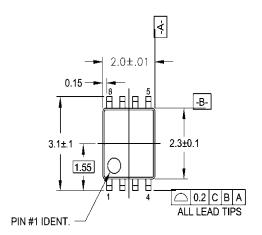
Dimensions are in inches (millimeters) unless otheriwise specified.

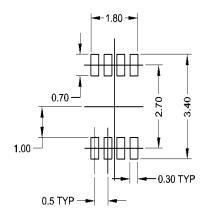


Tape Size	Α	В	С	D	N	W1	W2	W3
	7.0	0.059	0.512	0.795	2.165	0.331 + 0.059/-0.000	0.567	W1 + 0.078/-0.039
(8mm)	(177.8)	(1.50)	(13.00)	(20.20)	(55.00)	(8.40 + 1.50/-0.00)	(14.40)	(W1 + 2.00/-1.00)

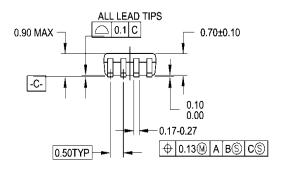
## **Physical Dimensions**

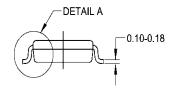
Dimensions are in millimeters unless otherwise noted.

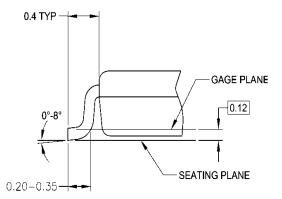




#### LAND PATTERN RECOMMENDATION







#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

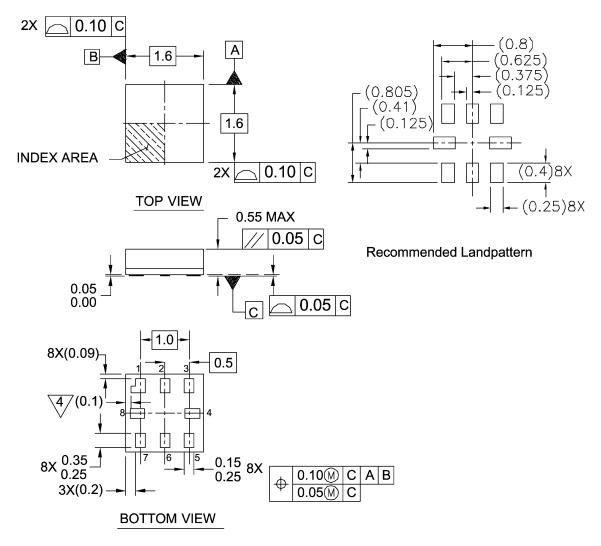
**DETAIL A** 

### MAB08AREVC

Figure 21. Pb-Free, 8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide

## Physical Dimensions (Continued)

Dimensions are in millimeters unless otherwise noted.



#### Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

Figure 22. Pb-Free, 8-Lead MicroPak, 1.6mm Wide

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POP™	SuperSOT™-3	
Power247™	SuperSOT™-6	
PowerEdge™	SuperSOT™-8	
PowerSaver™	SyncFET™	
	TCM™	
QFET <sup>®</sup>	TinyBoost™	
QS™	TinyBuck™	
QT Optoelectronics™	TinyPWM™	
Quiet Series™	TinyPower™	
RapidConfigure™	TinyLogic <sup>®</sup>	
RapidConnect™	TINYOPTO™	
μSerDes™	TruTranslation™	
ScalarPump™	UHC®	
	OCXPro <sup>TM</sup> OPTOLOGIC <sup>®</sup> OPTOPLANAR <sup>TM</sup> PACMAN <sup>TM</sup> POP <sup>TM</sup> Power247 <sup>TM</sup> PowerEdge <sup>TM</sup> PowerSaver <sup>TM</sup> PowerTrench <sup>®</sup> QFET <sup>®</sup> QS <sup>TM</sup> QT Optoelectronics <sup>TM</sup> Quiet Series <sup>TM</sup> RapidConfigure <sup>TM</sup> RapidConnect <sup>TM</sup>	$\begin{array}{llllllllllllllllllllllllllllllllllll$

Programmable Active Droop™

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.

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